

**Docket No. END920030022US1
(IEN-10-5752)**

APPLICATION DATA SHEET

INVENTOR INFORMATION::

Inventor One Given Name::	George H.
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ASSIGNEE INFORMATION::

ASSIGNEE::	International Business Machines Corporation
ASSIGNEE RESIDENCE::	Armonk, New York

CORRESPONDENCE INFORMATION::

Correspondence Customer Number:: 000026681

APPLICATION INFORMATION::

Title Line One::	METHOD AND STRUCTURE FOR SELF HEALING
Title Line Two::	CRACKS IN UNDERFILL MATERIAL BETWEEN
Title Line Three::	AN I/C CHIP AND A SUBSTRATE BONDED
Title Line Four::	TOGETHER WITH SOLDER BALLS
Total Drawing Sheets::	2
Formal Drawings?::	Yes
Application Type::	Utility
Docket Number::	END920030022US1 (IEN-10-5752)

REPRESENTATIVE INFORMATION::

Representative Customer Number:: 000026681

CONTINUITY INFORMATION::

This application is a::

> Application One::

Filing Date::

Patent Number::

PRIOR FOREIGN APPLICATIONS::

Foreign Application One:: No

Filing Date::

Country::

Priority Claimed::